

GI88L02

N-CHANNEL ENHANCEMENT MODE POWER MOSFET

BV _{DSS}	25V
R _{DS(ON)}	5mΩ
I _D	88A

Description

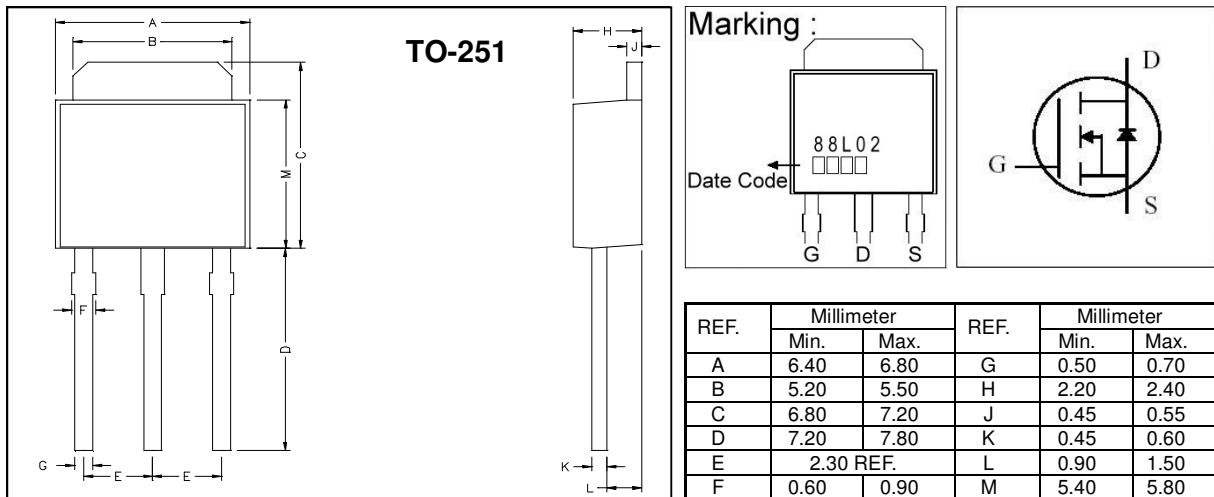
The GI88L02 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The through-hole version (TO-251) is available for low-profile applications and suited for low voltage applications such as DC/DC converters.

Features

- *Low Gate Charge
- *Simple Drive Requirement
- *Fast Switching

Package Dimensions



Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V _{DS}	25	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current, V _{GS} @10V	I _D @T _C =25°C	88	A
Continuous Drain Current, V _{GS} @10V	I _D @T _C =100°C	55	A
Pulsed Drain Current ¹	I _{DM}	321	A
Total Power Dissipation	P _D @T _C =25°C	96	W
Linear Derating Factor		0.77	W/°C
Operating Junction and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150	°C

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-case	R _{thj-case}	1.3	°C/W
Thermal Resistance Junction-ambient	R _{thj-amb}	110	°C/W

Electrical Characteristics (Tj = 25°C unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	BV _{DSS}	25	-	-	V	V _{GS} =0, I _D =250uA
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS} / \Delta T_j$	-	0.037	-	V/°C	Reference to 25°C, I _D =1mA
Gate Threshold Voltage	V _{GS(th)}	1.0	-	3.0	V	V _{DS} =V _{GS} , I _D =250uA
Forward Transconductance	g _{fs}	-	45	-	S	V _{DS} =10V, I _D =40A
Gate-Source Leakage Current	I _{GSS}	-	-	±100	nA	V _{GS} = ±20V
Drain-Source Leakage Current(Tj=25°C)	I _{DSS}	-	-	1	uA	V _{DS} =25V, V _{GS} =0
Drain-Source Leakage Current(Tj=150°C)		-	-	25	uA	V _{DS} =20V, V _{GS} =0
Static Drain-Source On-Resistance	R _{DS(ON)}	-	-	5	mΩ	V _{GS} =10V, I _D =40A
		-	-	10		V _{GS} =4.5V, I _D =28A
Total Gate Charge ²	Q _g	-	50	-	nC	I _D =40A V _{DS} =20V V _{GS} =5V
Gate-Source Charge	Q _{gs}	-	5.5	-		
Gate-Drain ("Miller") Change	Q _{gd}	-	38	-		
Turn-on Delay Time ²	T _{d(on)}	-	10.5	-	ns	V _{DS} =15V I _D =25A V _{GS} =10V R _G =3.3Ω R _D =0.6Ω
Rise Time	T _r	-	84	-		
Turn-off Delay Time	T _{d(off)}	-	38	-		
Fall Time	T _f	-	115	-		
Input Capacitance	C _{iss}	-	1660	-	pF	V _{GS} =0V V _{DS} =25V f=1.0MHz
Output Capacitance	C _{oss}	-	1000	-		
Reverse Transfer Capacitance	C _{rss}	-	400	-		

Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Forward On Voltage ²	V _{SD}	-	-	1.26	V	I _S =88A, V _{GS} =0V, Tj=25°C
Continuous Source Current (Body Diode)	I _S	-	-	88	A	V _D =V _G =0V, V _S =1.26V
Pulse Source Current (Body Diode) ¹	I _{SM}	-	-	321	A	

Notes: 1. Pulse width limited by safe operating area.

2. Pulse width ≤ 300us, duty cycle ≤ 2%.

Characteristics Curve

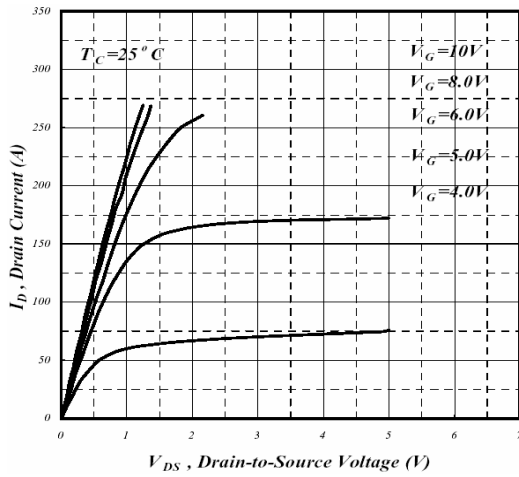


Fig 1. Typical Output Characteristics

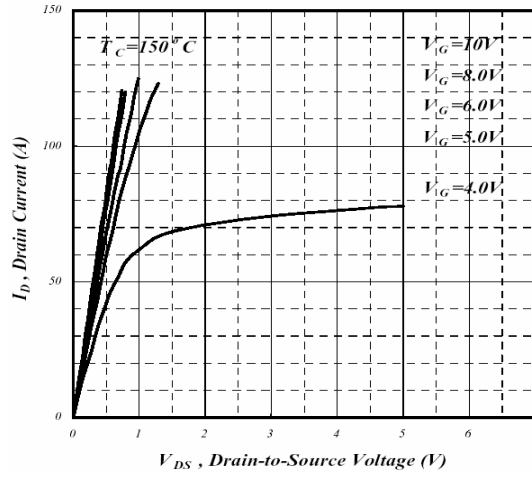


Fig 2. Typical Output Characteristics

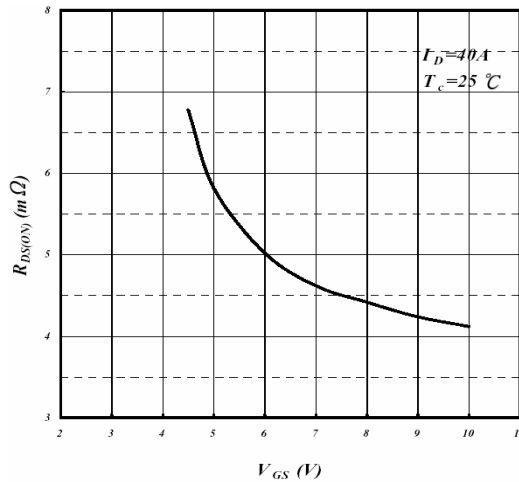


Fig 3. On-Resistance v.s. Gate Voltage

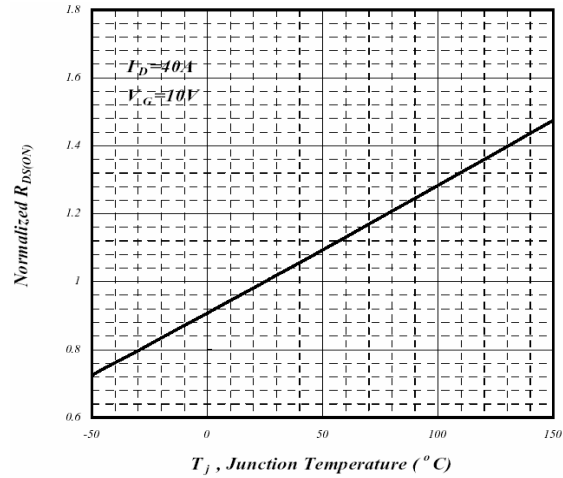


Fig 4. Normalized On-Resistance v.s. Junction Temperature

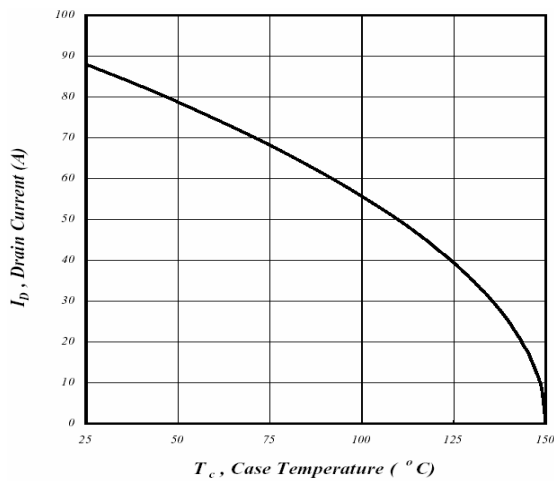


Fig 5. Maximum Drain Current v.s. Case Temperature

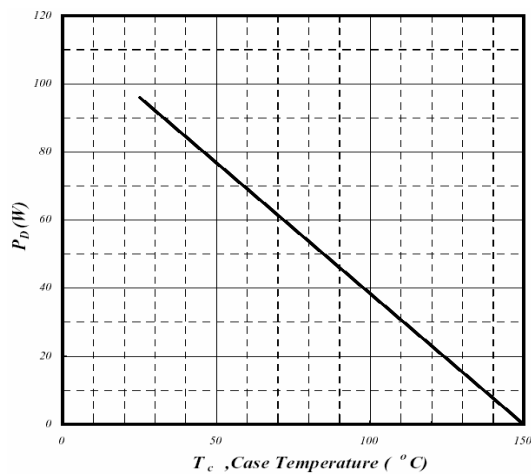


Fig 6. Type Power Dissipation

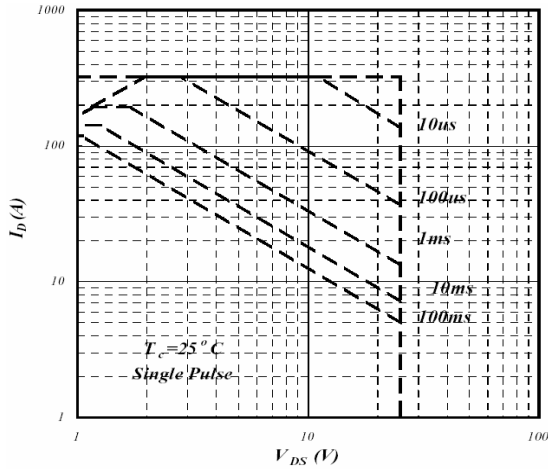


Fig 7. Maximum Safe Operating Area

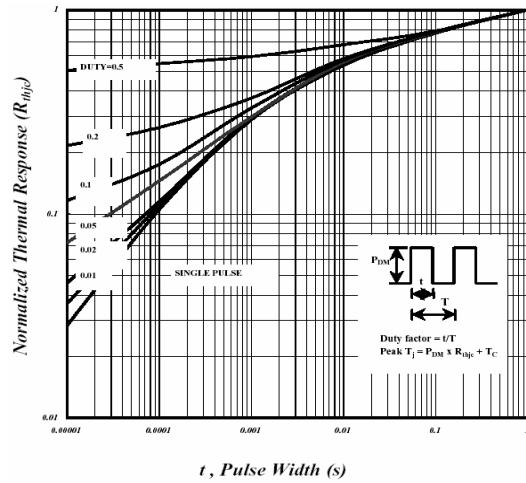


Fig 8. Effective Transient Thermal Impedance

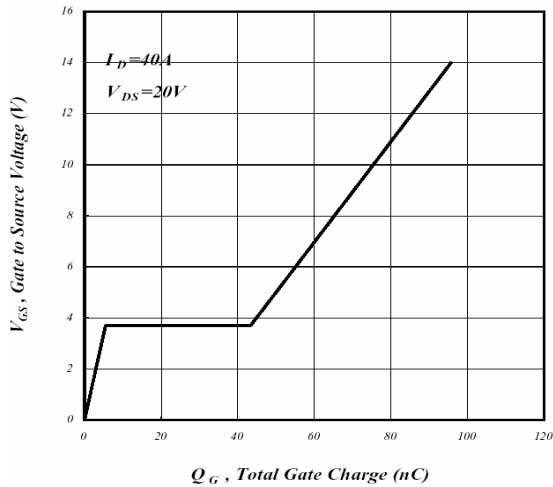


Fig 9. Gate Charge Characteristics

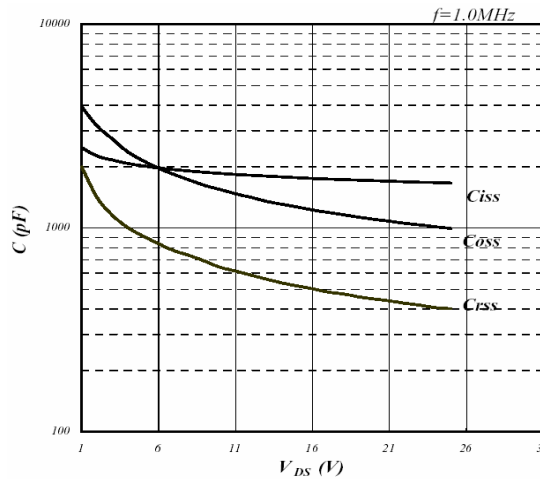


Fig 10. Typical Capacitance Characteristics

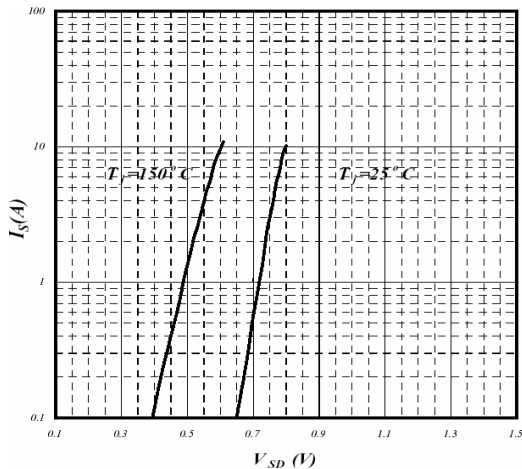


Fig 11. Forward Characteristics of Reverse Diode

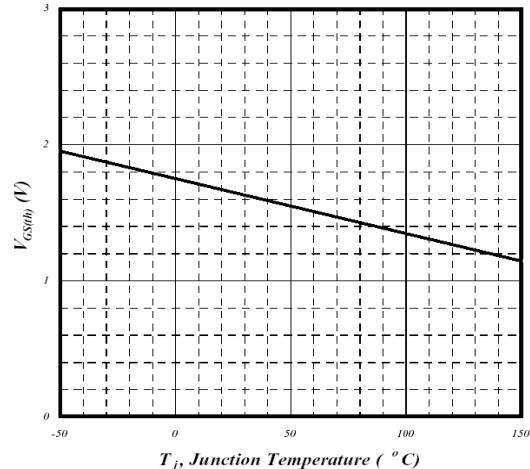


Fig 12. Gate Threshold Voltage v.s. Junction Temperature

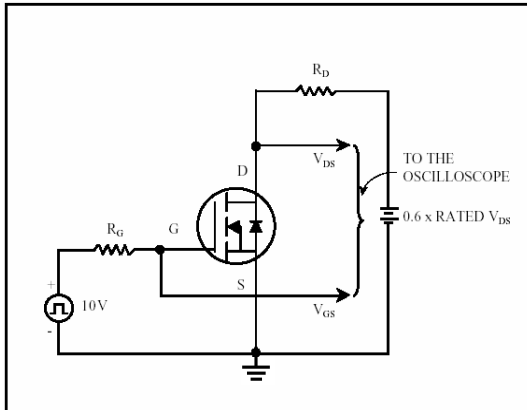


Fig 13. Switching Time Circuit

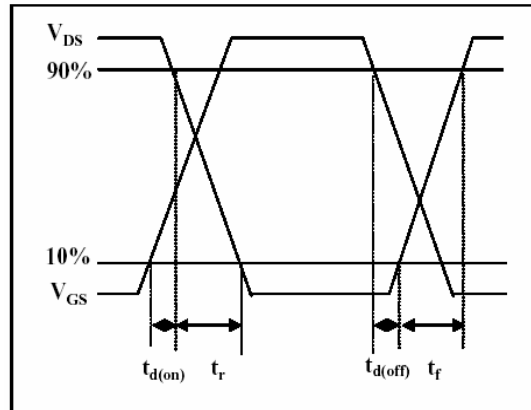


Fig 14. Switching Time Waveform

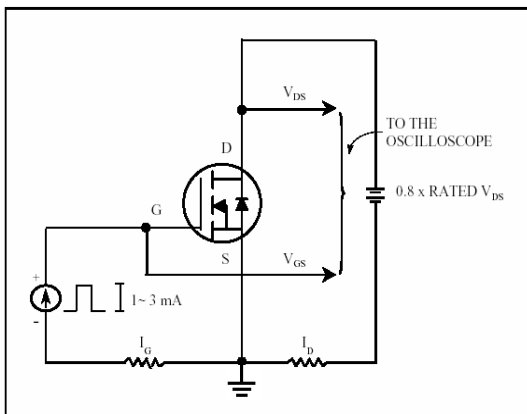


Fig 15. Gate Charge Circuit

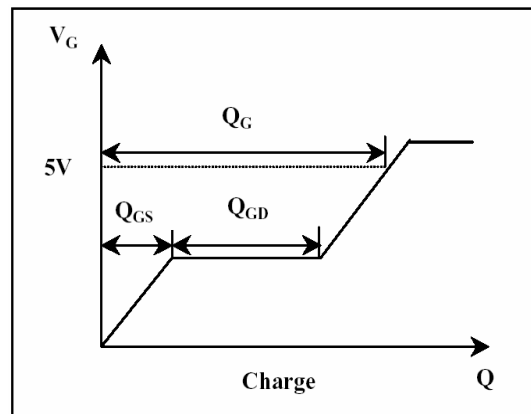


Fig 16. Gate Charge Waveform

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